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Application No.: 10/816,736

5

Docket No.: 247322002100

AMENDEMNTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

Claim 1 (original): A light-emitting apparatus package, comprising:

a ceramic substrate having an electric insulating property and a good heat conductivity;

a first concave section recessed in a thickness direction of the ceramic substrate, the first concave section providing a light exist aperture on a first surface of the ceramic substrate;

a second concave section, provided in the first concave section, and further recessed in the thickness direction of the ceramic substrate, the second concave section for providing an area for mounting a light-emitting device;

a wiring pattern provided in at least one of the first concave section and the second concave section, the wiring pattern for supplying electricity to the light-emitting device; and

a metalized layer, (i) provided on an inside-concave-section surface of the ceramic substrate in such a manner that the area for mounting the light-emitting device is sandwiched between the metalized layer and the light exit aperture, and in such a manner that the metalized layer is electrically insulated from the wiring pattern, the metalized layer having a light reflective property.

Claim 2 (original): The light-emitting apparatus package as set forth in Claim 1, further comprising:

an insulating layer under the wiring patterns,

the insulating layer being sandwiched between the metalized layer and the wiring patterns.

6

Docket No.: 247322002100

Claim 3 (original): The light-emitting apparatus package as set forth in Claim 1, further comprising:

a printed reflective section provided in that part of the inside-concave-section surface in which the metalized layer and the wiring pattern are not formed, the printed reflective section for reflecting light.

Claim 4 (original): The light-emitting apparatus package as set forth in Claim 1, wherein:

the metalized layer is exposed within the second concave section.

Claim 5 (original): The light-emitting apparatus package as set forth in Claim 1, wherein:

the ceramic substrate contains aluminum nitride.

Claim 6 (original): The light-emitting apparatus package as set forth in Claim 1, wherein:

the metalized layer functions as a part of a wiring pattern.

Claim 7 (original): The light-emitting apparatus package as set forth in Claim 1, further comprising:

a dam-for-resin section provided along a periphery of an aperture of the second concave section.

Claim 8 (original): The light-emitting apparatus package as set forth in Claim 1, further comprising:

7

Docket No.: 247322002100

a third concave section on a second surface of the ceramic substrate, the third concave section for mounting a chip component for stabilizing operation of the light-emitting device.

Claim 9 (original): A light-emitting apparatus, comprising:

- a light-emitting apparatus package including
- (i) a ceramic substrate having an electric insulating property and a good heat conductivity,
- (ii) a first concave section recessed in a thickness direction of the ceramic substrate, the first concave section providing a light exist aperture on a first surface of the ceramic substrate,
- (iii) a second concave section, provided in the first concave section, and further recessed in the thickness direction of the ceramic substrate, the second concave section for providing an area for mounting a light-emitting device,
- (iv) a wiring pattern provided in at least one of the first concave section and the second concave section, the wiring pattern for supplying electricity to the light-emitting device, and
- (v) a metalized layer, (i) provided on an inside-concave-section surface of the ceramic substrate in such a manner that the area for mounting the light-emitting device is sandwiched between the metalized layer and the light exit aperture, and in such a manner that the metalized layer is electrically insulated from the wiring pattern, the metalized layer having a light reflective property;

said light-emitting apparatus, comprising:

a light-emitting device, provided in the second concave section, the light-emitting device having an electrode on that part of the inside-concave-section surface in which no light-emitting device is provided;

8

Docket No.: 247322002100

a wire for electrically connecting the wiring pattern and the electrode of the lightemitting device; and

a transparent resin section for sealing the light-emitting device and the wire, the transparent resin having light transmitting property.

Claim 10 (original): A light-emitting apparatus, comprising:

a light-emitting apparatus package including

- (i) a ceramic substrate having an electric insulating property and a good heat conductivity,
- (ii) a first concave section recessed in a thickness direction of the ceramic substrate, the first concave section providing a light exist aperture on a first surface of the ceramic substrate,
- (iii) a second concave section, provided in the first concave section, and further recessed in the thickness direction of the ceramic substrate, the second concave section for providing an area for mounting a light-emitting device,
- (iv) a wiring pattern provided in at least one of the first concave section and the second concave section, the wiring pattern for supplying electricity to the light-emitting device, and
- (v) metalized layer, provided (1) on an inside-concave-section surface of the ceramic substrate in such a manner that the area for mounting the light-emitting device is sandwiched between the metalized layer and the light exit aperture, and (2) in such a manner that the metalized layer is electrically insulated from the wiring pattern, the metalized layer having a light reflective property;

said light-emitting apparatus, comprising:

Application No.: 10/816,736 9 Docket No.: 247322002100

a light-emitting device, provided in the second concave section, having an electrode in an area in which the light-emitting device is provided, and an electrode in an area in which no light-emitting device is provided;

a conductive adhesive section for connecting (a) the electrode in the area in which the light-emitting device is provided, and (b) the metalized layer, and for fixedly holding the light-emitting device on the metalized layer;

a wire for electrically connecting (a) the wiring pattern and (b) the electrode in the area in which no light emitting pattern is provided;

a resin section, provided on that part of an inside-surface of the first concave section, the resin section having a light reflecting property;

a transparent resin section for sealing the light-emitting device and the wire, the transparent resin having light transmitting property.

Claim 11 (original): A light-emitting apparatus, comprising:

- a light-emitting apparatus package including
- (i) a ceramic substrate having an electric insulating property and a good heat conductivity,
- (ii) a first concave section recessed in a thickness direction of the ceramic substrate, the first concave section providing a light exist aperture on a first surface of the ceramic substrate,
- (iii) a second concave section, provided in the first concave section, and further recessed in the thickness direction of the ceramic substrate, the second concave section for providing an area for mounting a light-emitting device,

10

Docket No.: 247322002100

- (iv) a wiring pattern provided in at least one of the first concave section and the second concave section, the wiring pattern for supplying electricity to the light-emitting device;
- (v) a metalized layer, provided (1) on an inside-concave-section surface of the ceramic substrate in such a manner that the area for mounting the light-emitting device is sandwiched between the metalized layer and the light exit aperture, and (2) in such a manner that the metalized layer is electrically insulated from the wiring pattern, the metalized layer having a light reflective property, and
- (vi) a dam-for-resin section provided along a periphery of an aperture of the second concave section,

said light-emitting apparatus, comprising:

a light-emitting device, provided in the second concave section, having an electrode in an area in which the light-emitting device is provided, and an electrode in an area in which no lightemitting device is provided;

a wire for electrically connecting (a) the wiring pattern and (b) the electrode in the area in which no light emitting pattern is provided;

a resin section, provided on that part of an inside-surface of the first concave section between the dam-for-resin section and the inside-surface of the first concave, the resin section having a light reflecting property;

a transparent resin section for sealing the light-emitting device and the wire, the transparent resin having light transmitting property.

Claim 12 (original): A light-emitting apparatus, comprising:

a light-emitting apparatus package including

11

Docket No.: 247322002100

- (i) a ceramic substrate having an electric insulating property and a good heat conductivity,
- (ii) a first concave section recessed in a thickness direction of the ceramic substrate, the first concave section providing a light exist aperture on a first surface of the ceramic substrate,
- (iii) a second concave section, provided in the first concave section, and further recessed in the thickness direction of the ceramic substrate, the second concave section for providing an area for mounting a light-emitting device,
- (iv) a wiring pattern provided in at least one of the first concave section and the second concave section, the wiring pattern for supplying electricity to the light-emitting device,
- (v) a metalized layer, provided (1) on an inside-concave-section surface of the ceramic substrate in such a manner that the area for mounting the light-emitting device is sandwiched between the metalized layer and the light exit aperture, and (2) in such a manner that the metalized layer is electrically insulated from the wiring pattern, the metalized layer having a light reflective property,
- (vi) a third concave section on a second surface of the ceramic substrate, the third concave section for mounting a chip component for stabilizing operation of the light-emitting device;

said light-emitting apparatus, comprising:

- a light-emitting device, provided in the second concave section, having an electrode in an area in which the light-emitting device is provided, and an electrode in an area in which no lightemitting device is provided;
- a wire for electrically connecting (a) the wiring pattern and (b) the electrode in the area in which no light emitting pattern is provided;

12

Docket No.: 247322002100

a resin section, provided on that part of an inside-surface of the first concave section, the resin section having a light reflecting property;

a transparent resin section for sealing the light-emitting device and the wire, the transparent resin having light transmitting property; and

a chip component provided within the third concave section.

Original 13 (original): A light-emitting apparatus, comprising:

one or more light-emitting devices for emitting light by converting a current into the light;

at least one light-emitting device substrate on a first surface of which at least one of the one or more of the light-emitting devices is provided;

a heat-discharging member bonded to at least one of a second surface and third surfaces of the light-emitting device substrate.

Claim 14 (original): The light-emitting apparatus as set forth in Claim 13, wherein:

only an adhesive agent and the light-emitting device substrate are provided between the light-emitting device and the heat discharging member, the adhesive agent for die-boding the light-emitting device and the light-emitting device substrate.

Claim 15 (original): The light-emitting apparatus as set forth in Claim 13, further comprising:

a connecting substrate, provided on the first surface of the light-emitting device substrate, having a predetermined wiring pattern for supplying electricity to said one or more lightemitting devices,

13

Docket No.: 247322002100

the connecting substrate having a light-transmitting section provided in a position, corresponding to a position of said one or more light-emitting devices.

Claim 16 (original): The light-emitting apparatus as set forth in Claim 15, wherein:

the light-emitting device substrate includes a electrode-wiring terminal in at least one of both edges of the surface of the light-emitting device substrate, the electrode-wiring terminal for establishing connection with a predetermined wiring pattern provided on the connecting substrate.

Claim 17 (original): The light-emitting apparatus as set forth in Claim 16, wherein:

a plurality of the light-emitting device substrates are arranged in one or more lines and the predetermined wiring patterns of the plurality of the light-emitting device substrates are electrically connected with electrode-wiring terminal of the connecting substrate.

Claim 18 (original): The light-emitting apparatus as set forth in Claim 13, wherein: the light-emitting device substrate is a ceramic substrate.

Claim 19 (original): The light-emitting apparatus as set forth in Claim 13, wherein: the light-emitting device is a light-emitting diode chip.

Claim 20 (original): The light-emitting apparatus as set forth in Claim 19, wherein: a plurality of the light-emitting devices emit light in different colors from the others.

Claim 21 (original): The light-emitting apparatus as set forth in Claim 13, wherein:

the light-emitting device is die-bonded to a predetermined position of the wiring pattern provided on the first surface of the light-emitting device substrate, and

14

Docket No.: 247322002100

an electrode of the light-emitting device is wire-bonded to another predetermined position of the wiring pattern via a connecting wire.

Claim 22 (original): The light-emitting apparatus as set forth in Claim 21, wherein:

a concave section is provided on the surface of the light-emitting device substrate, the light-emitting device being die-bonded to a predetermined position of a wiring pattern provided within the concave section;

the light-emitting device mounting substrate has a concave section on the first surface thereof; and

the light-emitting device is die-bonded to a predetermined position of a wiring pattern provided within the concave section.

Claim 23 (original): The light-emitting apparatus as set forth in Claim 22, wherein:

the concave section includes a deeper concave section in a center section thereof, and a shallower concave section around the deeper concave section, and

the light-emitting device is die-bonded to a predetermined position of a wiring pattern provided within said deeper concave section, whereas an electrode of said light-emitting device is wire-bonded to a predetermined position of a wiring pattern provided within said shallower concave section.

Claim 24 (original): The light-emitting apparatus as set forth in Claim 21, wherein:

the light-emitting device is die-bonded to a predetermined position of a wiring pattern provided on a flat surface of the light-emitting device substrate.

Application No.: 10/816,736 15 Docket No.: 247322002100

Claim 25 (original): The light-emitting apparatus as set forth in Claim 15, wherein:

the light-transmitting section includes a lens means for preventing dispersion of light that is emitted from the light-emitting device.

Claim 26 (original): The light-emitting apparatus as set forth in Claim 15, wherein: the light-transmitting section is a window section.

Claim 27 (original): The light-emitting apparatus as set forth in Claim 25, wherein:

the lens means is fitted in a window section as light-transmitting section the so that the lens means is not protruded out above the first surface of the connecting substrate.

Claim 28 (original): The light-emitting apparatus as set forth in Claim 25, wherein: the lens means is a micro lens means.

Claim 29 (original): The light-emitting apparatus as set forth in Claim 28, wherein:

the micro lens mean is located on a surface of the connecting substrate, the surface being reverse to the surface that faces the light-emitting substrate;

the micro lens means includes:

a transparent sheet member; and

a plurality of micro lenses on said transparent sheet member, the plurality of micro lenses arranged in one or more lines.

Claim 30 (original): The light-emitting apparatus as set forth in Claim 15, wherein: the connecting substrate is made of a transparent material having no color; and

16

Docket No.: 247322002100

the lens means is incorporated in the connecting substrate.

Claim 31 (original): The light-emitting apparatus as set forth in Claim 21, wherein:

a periphery of the light-emitting device and a periphery of the connecting wire are molded with resin.

Claim 32 (original): The light-emitting apparatus as set forth in Claim 25, wherein:

the lens means is a dorm-like section shaped at the surface of the resin molding which molds at least a periphery of the light-emitting device.

Claim 33 (original): The light-emitting apparatus as set forth in Claim 31, wherein:

the resin contains a fluorescer, which emits light in a desired color by being exited by the light emitted from the light-emitting device.

Claim 34 (original): The light-emitting apparatus as set forth in Claim 15, wherein:

the connecting substrate includes, on a surface thereof, a transparent sheet member containing a fluorescer, which emits light in a desired color by being exited by the light emitted from the light-emitting device, the surface being reverse to the surface that faces the light-emitting substrate.

Claim 35 (original): The light-emitting apparatus as set forth in Claim 33, wherein:

the light-emitting device emits light in a color in a blue or a ultra violet region.

Claim 36 (original): A backlight apparatus, comprising:

a light-emitting apparatus; and

Application No.: 10/816,736 17 Docket No.: 247322002100

a light guide plate whose light-receiving end face faces a light-emitting surface of said light-emitting apparatus, said light guide plate propagating therethrough light received on said light-receiving end face, and then emitting the light from a surface,

said light-emitting apparatus including (i) one or more light-emitting devices which emit light when electricity is supplied, (ii) a light-emitting device substrate having at least one of the light-emitting devices provided on a surface of the light-emitting device substrate, and (iii) a heat-discharging member which is bonded to any one of a second surface and third surfaces of the light-emitting device substrate.

Claim 37 (original): A display apparatus, comprising:

a display panel having a pair of substrates, which sandwich a displaying medium therebetween, said display panel displaying by applying a display voltage between the substrates;

a backlight apparatus provided on a second surface of said display panel,

the backlight apparatus including (i) a light-emitting apparatus, and (ii) a light guide plate whose light-receiving end face faces a light-emitting surface of said light-emitting apparatus, said light guide plate propagating therethrough light received on said light-receiving end face, and then emitting the light from a surface,

said light-emitting apparatus including (i) one or more light-emitting devices which emit light when electricity is supplied, (ii) a light-emitting device substrate having at least one of the light-emitting devices provided on a surface of the light-emitting device substrate, and (iii) a heat-discharging member which is bonded to any one of a second surface and third surfaces of the light-emitting device substrate.

Claim 38 (original): The display apparatus as set forth in Claim 37, wherein:

Application No.: 10/816,736 18 Docket No.: 247322002100

the display panel is a liquid crystal display panel in which the displaying medium is a liquid crystal layer sandwiched between the pair of the substrates, and said liquid crystal display panel displaying by changing orientation of a liquid crystal molecule in each of picture elements by applying a display voltage between the substrates, the picture elements being arranged in matrix.

Claim 39 (new): A light-emitting apparatus package, comprising:

a ceramic substrate having an electric insulating property and a good heat conductivity;

a first concave section recessed in a thickness direction of the ceramic substrate, the first concave section providing a light exist aperture on a first surface of the ceramic substrate;

a second concave section, provided in the first concave section, and further recessed in the thickness direction of the ceramic substrate, the second concave section for providing an area for mounting a light-emitting device; and

a wiring pattern provided in at least one of the first concave section and the second concave section, the wiring pattern for supplying electricity to the light-emitting device.